

MGV High Current Molded SMT Power Inductors MGV0412 Series

FEATURES AND APPLICATIONS

Laird MGV series high current power inductors improve performance, reliability and power efficiency. A lower profile benefits consumer electronics and telecom design. Products feature extremely low DCR with greater efficiency and enable a large current in a small size. Inductors are of magnetic shielding and molded construction and perform in operating temperatures ranging from -55 C to 125 C including self-heating rise in temperature.

FEATURES

- Magnetic shielded structure
- Low DCR and high efficiency
- Low profile and miniaturization
- High reliability

APPLICATIONS

code

- DC-DC Converter and Power Suppliers
- LCD TV'S and Gaming Console
- Tablet, Notebooks, Servers and Printers
- Networking and Data storage
- GPS, Set-top-box and Base stations
- Smart meters and Medical instruments

PART NUMBER EXPLANATION



MGV	0412	4 R 7	Μ -	10
Product series	Product size	Inductance	Tolerance %	Standard

code value code (i.e. M: \pm 20%) Catalog P.N μ H)

Note: Automotive grade parts are also available, a specific P.N will be assigned upon request. Please contact laird local sales for details.

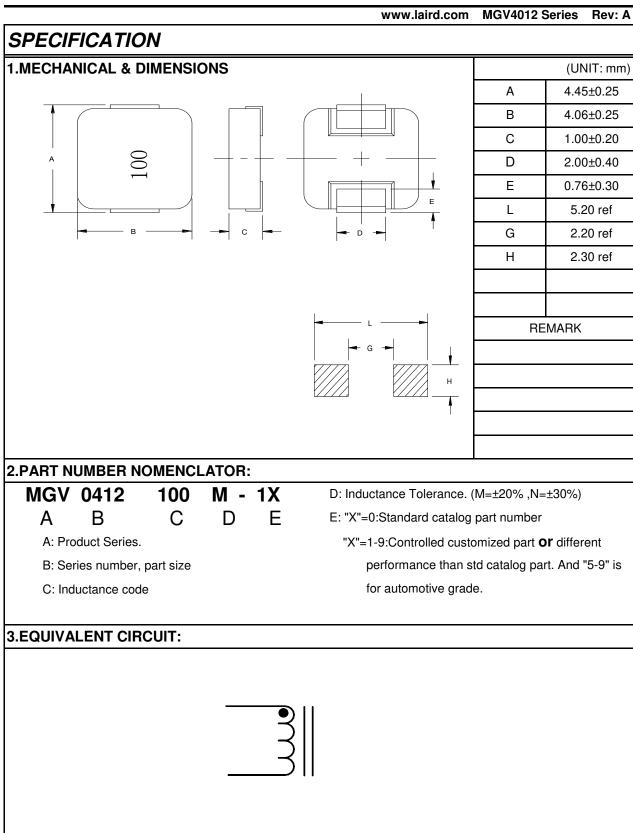
ELECTRICAL SPECIFICATIONS

- Tolerance: M: ±20% or N: ±30%
- Inductance tested at 100KHz, 1.0V
- Heat Rated Current (Irms) is defined based on temperature rise approximate 40°C without core loss (ambient temperature 25±5°C)
- Saturation Current (Isat) is the DC current at which the inductance drops off approximately 30% from its value without current. (ambient temperature 25±5°C)
- Operating temperature range: -40°C~+125°C (including self-heating temperature rise)
- Storage temperature range (packaging conditions): -10°C~+40°C and RH 60%(MAX.)

Note: Heat Rated Current (Irms) is tested on a typical PCB and apply a constant current in still air. The temperature rise is dependent on the application system condition including PCB PAD pattern, trace width and thickness and adjacent components etc. It's suggested to verify the temperature rise of the component under the real operation application conditions.



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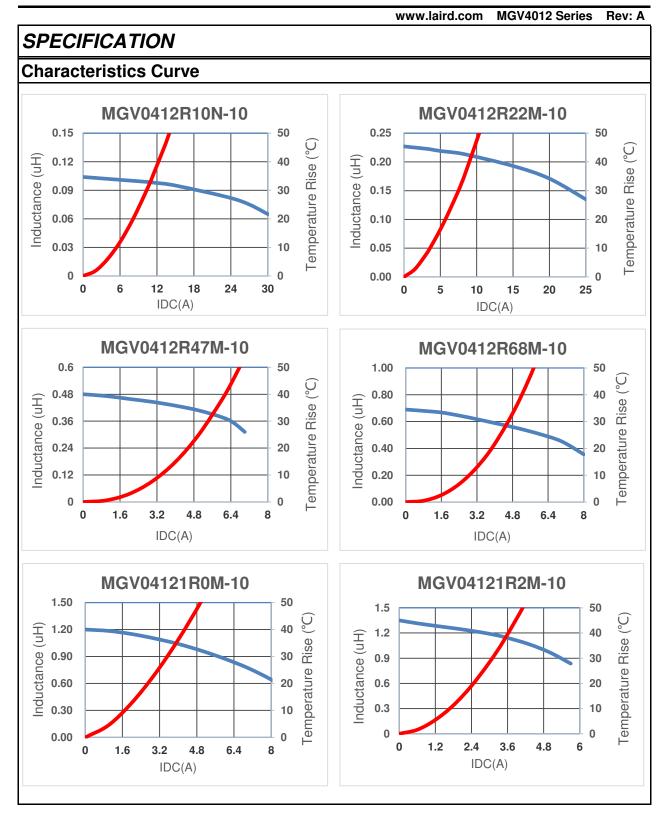


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				www.laird.com	MGV4012 Seri	es Rev:
SPECIFICATI	ION					
PART NUMBER	INDUCTANCE (uH)	Irms(A) Typ.	Isat(A) Typ.	DCR(mΩ) Typ	DCR(mΩ) Max	REMARK
MGV0412R10N-10	0.10±30%	11.5	25.0	4.3	5.5	
MGV0412R22M-10	0.22±20%	8.5	20.0	6.6	8.0	
MGV0412R47M-10	0.47±20%	6.0	6.5	18.0	20.0	
MGV0412R68M-10	0.68±20%	5.0	6.0	32.0	37.0	
MGV04121R0M-10	1.00±20%	4.0	6.0	41.0	47.0	
MGV04121R2M-10	1.20±20%	3.5	5.0	48.0	56.0	
MGV04121R5M-10	1.50±20%	3.0	4.0	55.0	63.3	
MGV04122R2M-10	2.20±20%	2.8	3.5	69.2	80.0	
MGV04123R3M-10	3.30±20%	2.3	3.0	84.0	97.0	
MGV04124R7M-10	4.70±20%	2.0	2.5	128.0	145.0	
MGV04126R8M-10	6.80±20%	1.5	1.7	300.0	360.0	
MGV0412100M-10	10.0±20%	1.3	1.4	410.0	463.0	
MGV0412220M-10	22.0±20%	0.8	1.0	950.0	1050.0	
SENERAL SPECI						
Heat Rated Current	-	used on tempe	erature rise ap	proximate 40°C v	without core loss	
(ambient temperatu		•	•	•		
Saturation Current (Isat) is the DC curre	ent at which th	ne inductance	drops off approx	kimately 30% from	n
its value without cu	ırrent. (ambient ter	nperature 25±	±5°C)			
Operating temperat	ure range: -40°C~+	125°C (includi	ng self-heatin	g temperature ri	se)	
Storage temperatur	e range (nackaging	conditions);	10°C~+40°C a	nd RH 60%(MAX	١	

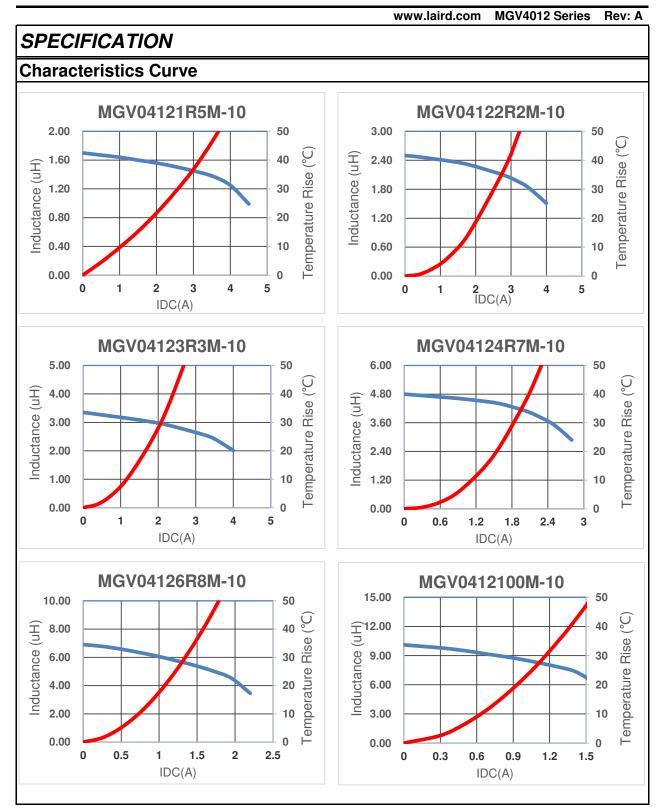


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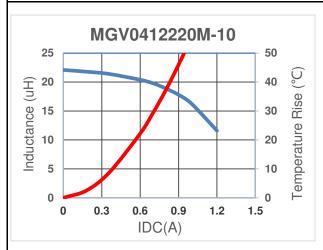




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SPECIFICATION

Characteristics Curve



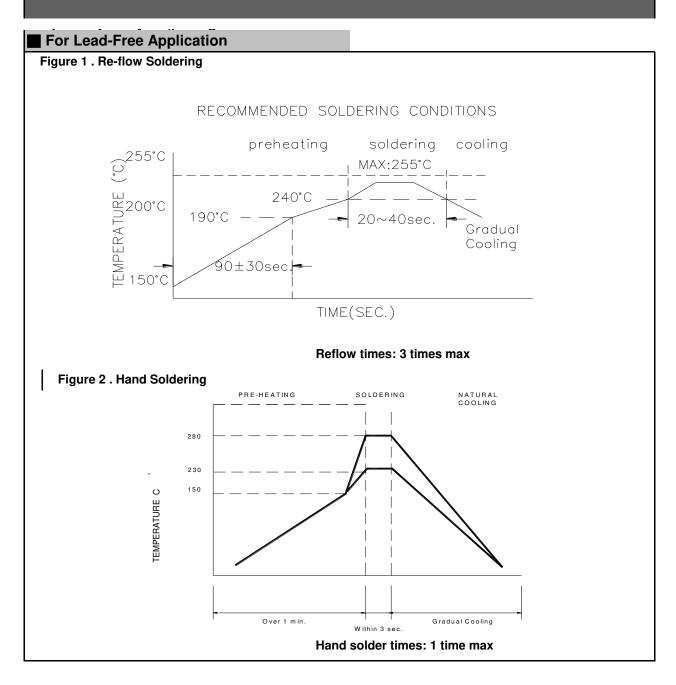


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Molded SMT Power Inductor

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Recommended Soldering Conditions





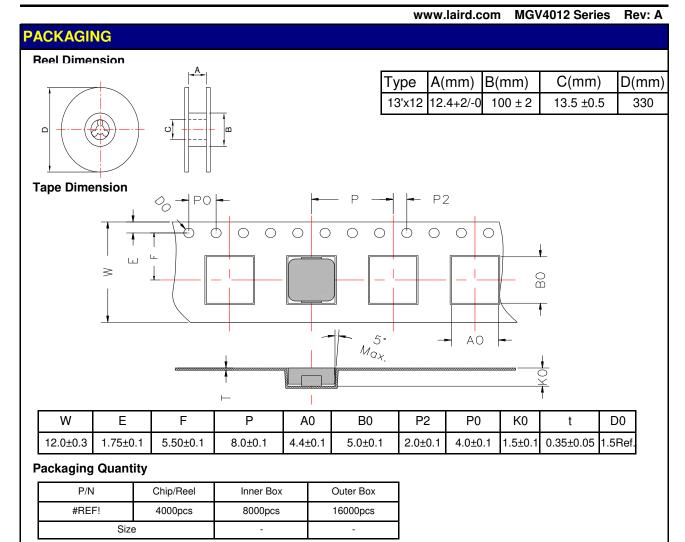
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		www.laird.com MGV4012 Series Rev: A				
Reliability and Te	stina Conditions / Pin Tvpe Po	wer inductors				
SMD series(Consumer)						
Item	Reference	Additional Requirements				
Operating temperature range	-55°C ~ +125°C (Including self-temperature rise)					
Storage temperature and humidity range	-10 $^\circ\!\!\!{\rm C}$ to +40 $^\circ\!\!\!{\rm C}$, 60% RH Max					
High Temperature Exposure (Storage)	MIL-STD-202 Method 108	85±2℃, 168+24hours				
Temperature Cycling	JESD22 Method JA-104	-40°C→+85, transforming interval:20s, 100cycles				
Operational Life	MIL-PRF-2	85±℃, 168+24hours Apply maximum rated voltage and current according part drawing				
External Visual	MIL-STD-883 Method 2009	Inspect device construction, marking and workmanship. Electrica Test not required.				
Physical Dimension	JESD22 Method JB-100	Verify physical dimensions to the applicable device detail specification. Note: User(s) and Suppliers spec. Electrical Test not required				
Vibration	MIL-STD-202 Method 204	10~55Hz,1.5mm, 2 hours in each 3mutually perpendicular directions (total of 6 hours)				
Resistance to Soldering Heat	MIL-STD-202 Method 210	1. Max. 260±5°C,10±1s, 2 times 2.Solder Composition: Sn/3Ag/0.5Cu				
Solderability	J-STD-002	245±5°C, 5±1sec, Solder: Sn/3.0Ag/0.5Cu				
Electrical Characterization	Print Spec	Parametrically test per lot and sample size requirements, summary to show Min, Max, Mean and Standard deviation at room as well as Min and Max Operating temperatures				
Board Flex	AEC-Q200-005	2mm,30±1s				
Terminal Strength(SMD)	AEC-Q200-006	10N, 5S, X,Y direct				

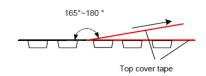


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Molded SMT Power Inductor



Peeling Off Force



The force peeling off cove tape is 10 to 100 grams				
in the arrow direction under the following conditions				
Room Temp (℃)	Room Humidity	Room atrn (hPa)	Teaming Speed	
5~35	45~85	860~1060	300	

Storage Conditions

- 1. Temperature and humidity conditions: -10-+40 $^\circ\!\mathrm{C}$
- and 60% RH.

2. Recommended products should be used within 12 month

from the time of manufacturing.

3. The packaging material should be kept where no chlorine

or sulfur exists in the air.

4. Allowable stacking condition of Packaging box: max height 1.5m or 5 boxes stacking